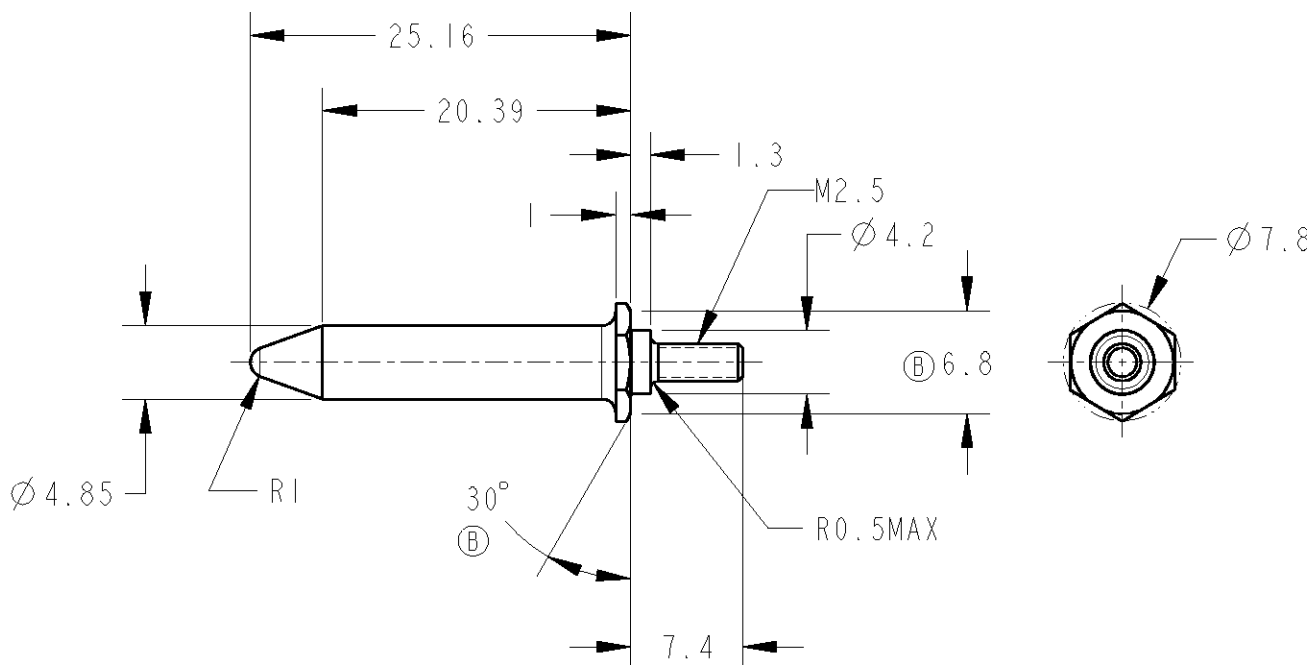


LOC	DIST	REVISIONS 変更					
		P	LTR	DESCRIPTION	DATE	DWN	APVD
J	-	B		REDRAWN, REVISED FJB0-0208-03	19MAR2003	C.O	I.E



△仕上げ; 全面無電解めっき  
銅下地めっき1μm最小の上に、ニッケルめっき2μm最小

△FINISH; WHOLE SURFACE ELECTROLESS PLATING  
0.001mm MIN THK. Cu UNDER PLATING  
0.002mm MIN THK. Ni SURFACE PLATING

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DIMENSIONS: 単位: 耗 mm	DWN C. OHASHI	19MAR2003	MATERIAL 材料	STEEL	FINISH 仕上	SEE NOTE 1
	CHK K. IKEGAMI	19MAR2003	Tyco Electronics AMP K.K. Kawasaki, Japan			
TOLERANCES UNLESS OTHERWISE SPECIFIED:	APVD I. ENOMOTO	19MAR2003				
一般公差	PRODUCT SPEC 製品規格	-	GUIDE PIN FOR HS3 (SHORT)			
0 PLC ±-	APPLICATION SPEC 取付適用規格	-	SIZE	CAGE CODE	DRAWING NO 番号	RESTRICTED TO
1 PLC ±0.3	WEIGHT	-	A4	00779	C=1318744	-
2 PLC ±0.2	CUSTOMER DRAWING		SCALE 尺度	2:1	SHEET 頁	1 OF 1
3 PLC ±						REV B
4 PLC ±						
ANGLES ±-						

单击下面可查看定价，库存，交付和生命周期等信息

[>>TE Connectivity\(泰科\)](#)